

Absolute Maximum Ratings
(Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	60	mA
	Reverse voltage	V _R	6	V
	Power dissipation	P _D	100	mW
	Derating factor (above T _a = 85°C)		3.8	mW /°C
Output			EL301X	250
	Off-state Output Terminal Voltage	V _{DRM}	EL302X	400
			EL305X	600
	Peak Repetitive Surge Current (pw=100μs,120pps)	I _{TSM}	1	A
	On-State RMS Current	I _{T(RMS)}	100	mA
	Power dissipation Derating factor (above T _a = 85°C)	P _C	300	mW
			7.4	mW/°C
	Total power dissipation	P _{TOT}	330	mW
	Isolation voltage ^{*1}	V _{ISO}	5000	Vrms
	Operating temperature	T _{OPR}	-55 to 100	°C
	Storage temperature	T _{STG}	-55 to 125	°C
	Soldering Temperature ^{*2}	T _{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2&3 are shorted together, and pins 4, 5 & 6 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.* ¹	Max.	Unit	Condition
Forward Voltage	V _F	-	1.18	1.5	V	I _F = 10mA
Reverse Leakage current	I _R	-	-	10	μA	V _R = 6V

Output

Parameter	Symbol	Min.	Typ.* ¹	Max.	Unit	Condition
Peak Blocking Current	I _{DRM}	-	-	100	nA	V _{DRM} = Rated V _{DRM} I _F = 0mA* ²
Peak On-state Voltage	V _{TM}	-	-	2.5	V	I _{TM} =100mA peak, I _F =Rated I _{FT}
Critical Rate of Rise off-state Voltage	EL301X EL302X EL305X dv/dt	- 1000	100 -	- -	V/μs	V _{PEAK} =Rated V _{DRM} , I _F =0 (Fig. 8)* ³ V _{PEAK} =400V, I _F =0 (Fig. 8)

Notes:

*1. Typical values at T_a = 25°C

*2. Test voltage must be applied within dv/dt rating.

*3. This is static dv/dt. See Figure 8 for test circuit. Commutating dv/dt is a function of the load-driving thyristor(s) only.

Transfer Characteristics

Parameter	Symbol	Min.	Typ.*1	Max.	Unit	Condition
LED Trigger Current	EL3020			30		Main terminal Voltage=3V*4
	EL3010					
	EL3021	-	-	15		
	EL3051					
	EL3011					
	EL3022	-	-	10		
	EL3052					
	EL3012					
	EL3023	-	-	5		
	EL3053					
Holding Current	I _H	-	250	-	μA	

Notes:

- *4. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT}. Therefore, recommended operating I_F lies between max I_{FT} (30 mA for EL3020, 15 mA for EL3010/EL3021/EL3051, 10 mA for EL3011/EL3022/EL3052, 5 mA for EL3012/EL3023/EL3053) and absolute maximum I_F (60 mA).

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Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

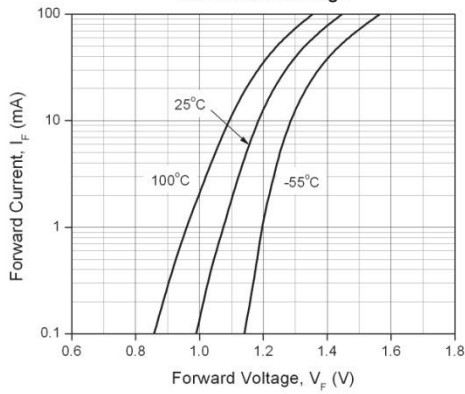


Figure 2. On-State Characteristics

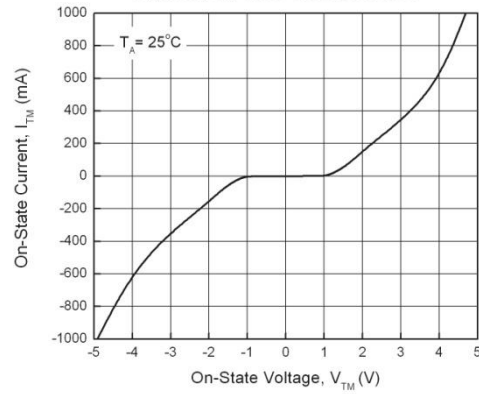


Figure 3. Holding Current vs. Ambient Temperature

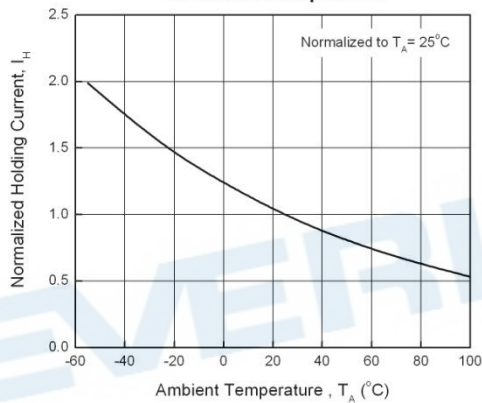


Figure 4. LED Current Required to Trigger vs. LED Pulse Width

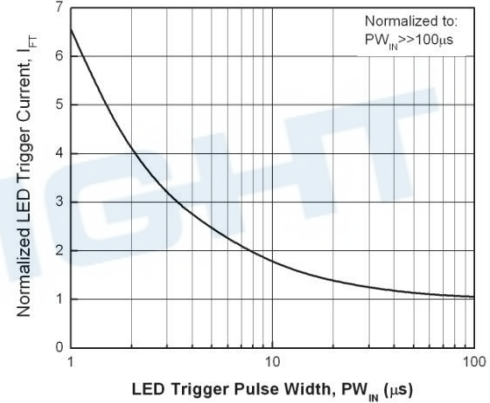


Figure 5. Leakage Current vs. Ambient Temperature

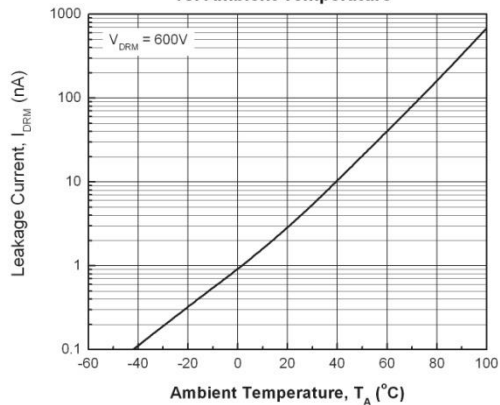


Figure 6. LED Trigger Current vs. Ambient Temperature

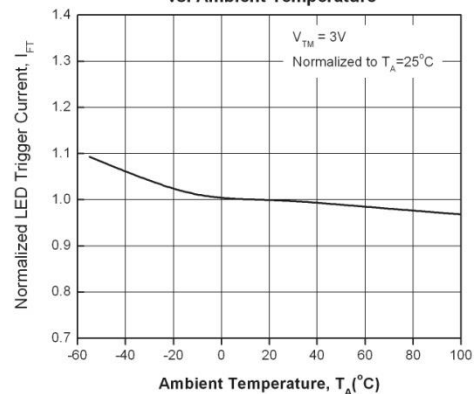
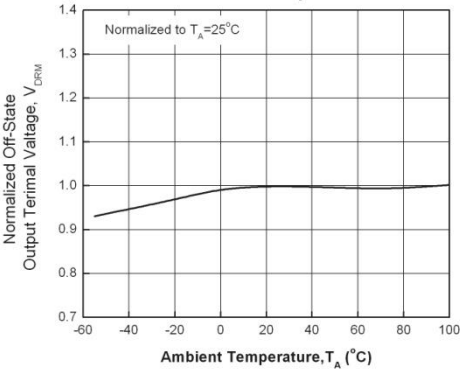
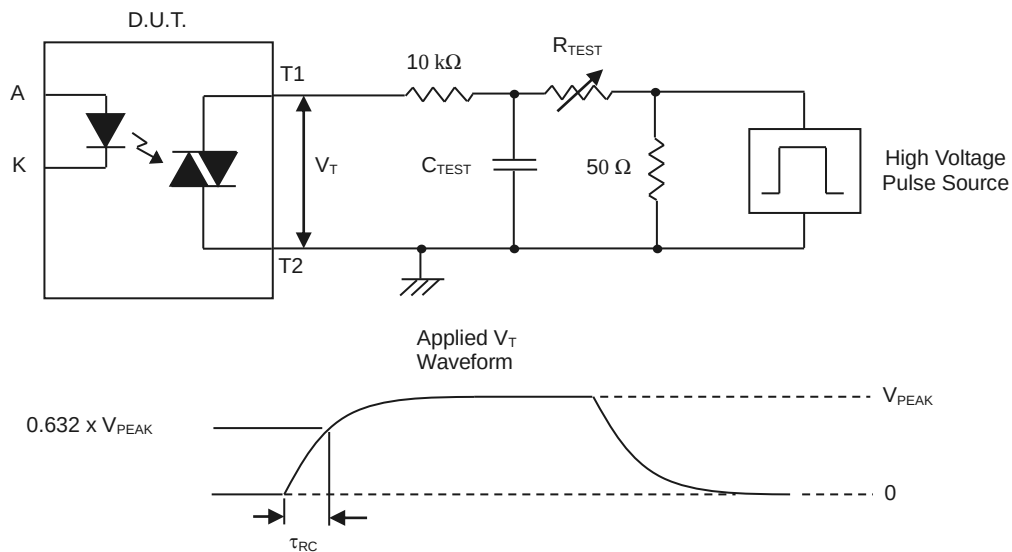


Figure 7. Off-State Output Terminal Voltage
vs. Ambient Temperature



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Figure 8. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, $V_{PEAK} = 400V$ for EL302X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.632 \times 400}{\tau_{RC}} = \frac{252.8}{\tau_{RC}}$$

Order Information

Part Number

EL301XY(Z)-V
or **EL302XY(Z)-V**
or **EL305XY(Z)-V**

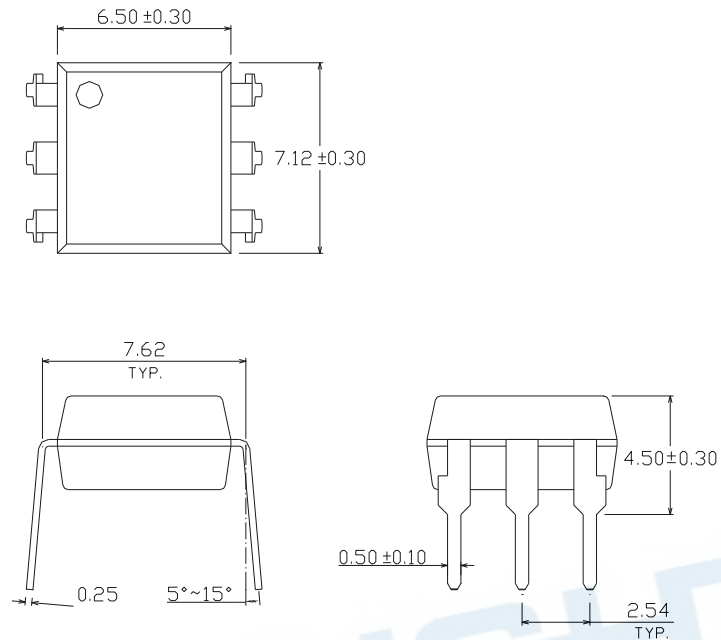
Notes

- X = Part No. for EL301x (0, 1 or 2).
- X = Part No. for EL302x (0,1, 2 or 3)
- X = Part No. for EL305x (1, 2 or 3)
- Y = Lead form option (S, S1, M or none)
- Z = Tape and reel option (TA, TB or none).
- V = VDE safety approved (optional)

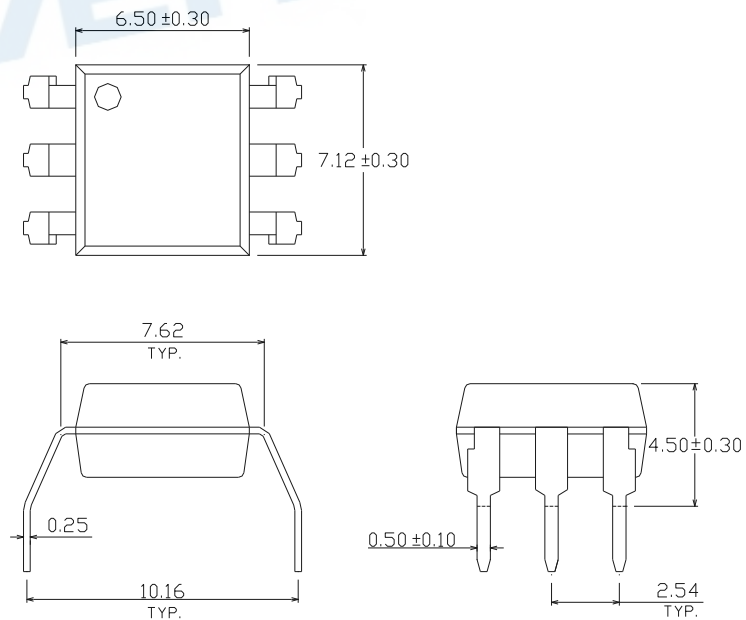
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
M	Wide lead bend (0.4 inch spacing)	65 units per tube
S	Surface mount lead form	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

Package Dimension (Dimensions in mm)

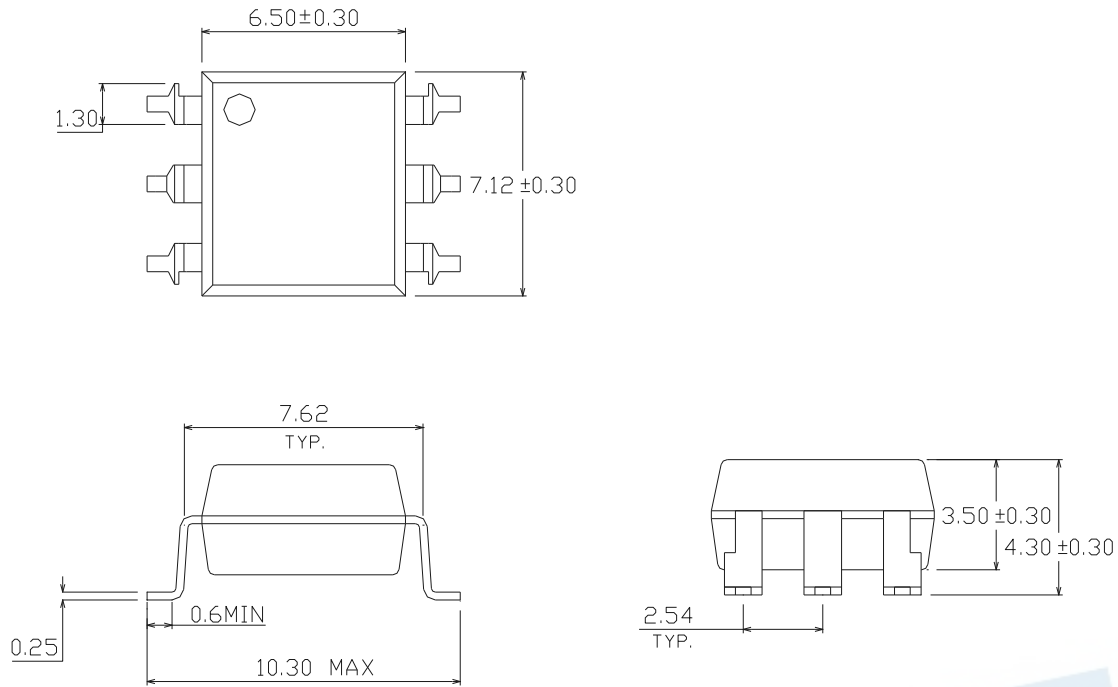
Standard DIP Type



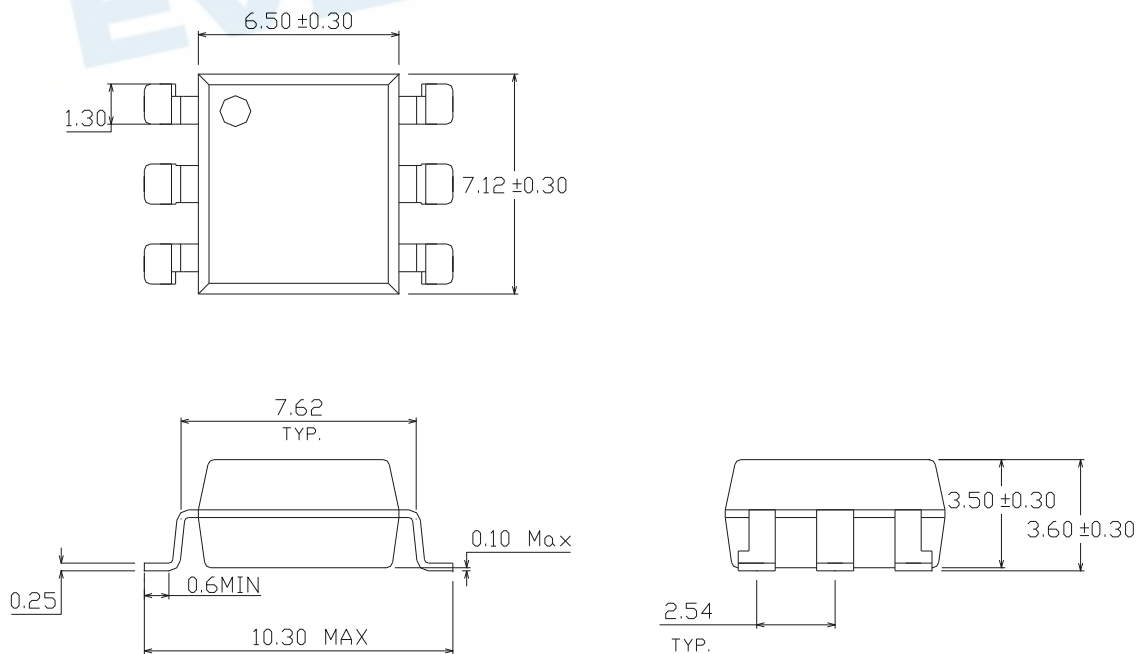
Option M Type



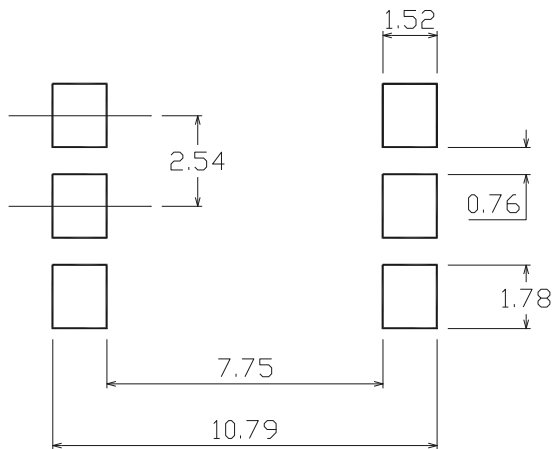
Option S Type



Option S1 Type



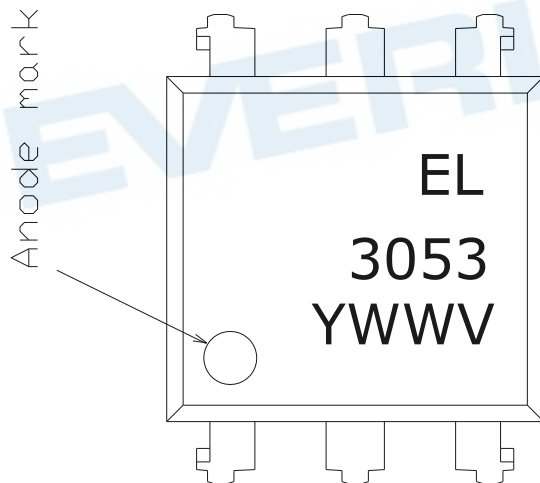
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Device Marking

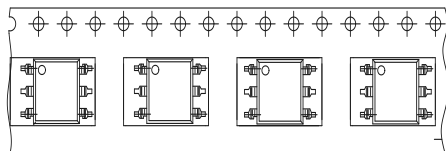


Notes

EL denotes EVERLIGHT
3053 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)

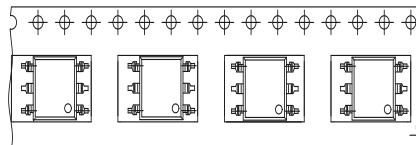
Tape & Reel Packing Specifications

Option TA



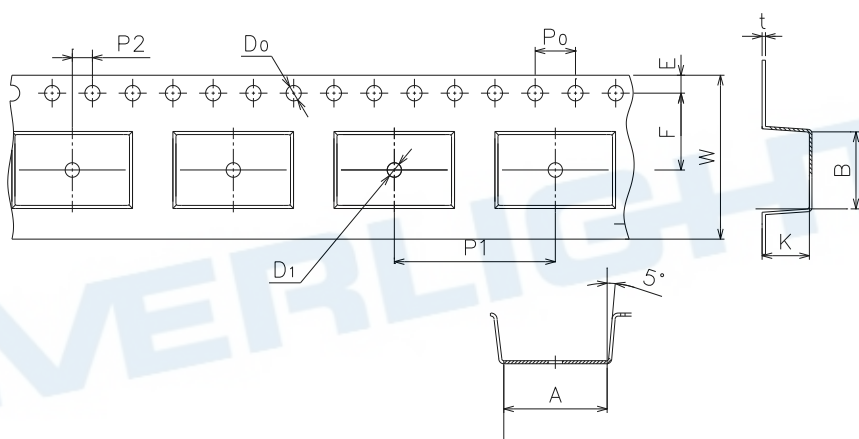
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions

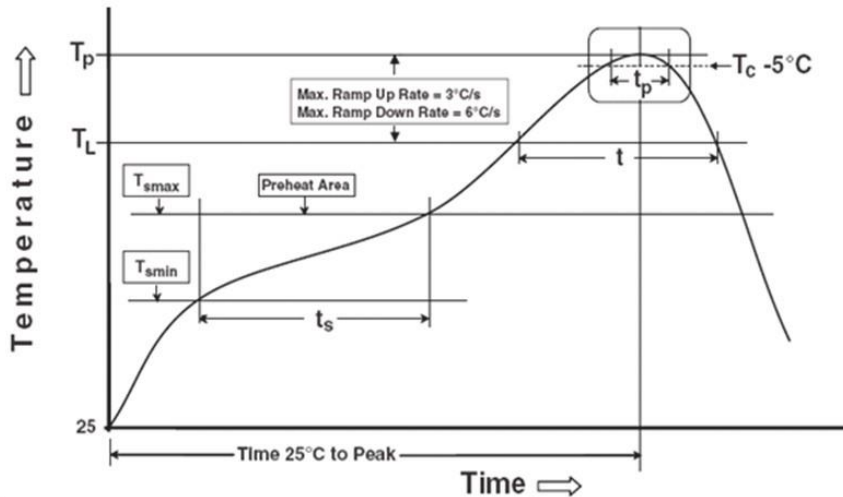


Dimension No.	A	B	D0	D1	E	F
Dimension (mm)	10.8±0.1	7.5±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1
Dimension No.	P0	P1	P2	t	W	K
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Notes

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_P)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: $T_P - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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